



High-end Power Semiconductor Manufacturer

# KP1600A 5400V-6500V Phase Control Thyristor

- High power cycling capability
- Low on-state and switching losses
- Designed for traction and industrial applications



|                                   |           |               |      |      |      |      |      |      |
|-----------------------------------|-----------|---------------|------|------|------|------|------|------|
| Mean on-state current             | $I_{TAV}$ | 1600 A        |      |      |      |      |      |      |
| Repetitive peak off-state voltage | $V_{DRM}$ | 5400 – 6500 V |      |      |      |      |      |      |
| Repetitive peak reverse voltage   | $V_{RRM}$ |               |      |      |      |      |      |      |
| Turn-off time                     | $t_q$     | 800 $\mu$ s   |      |      |      |      |      |      |
| $V_{DRM}, V_{RRM}, V$             |           | 5400          | 5600 | 5800 | 6000 | 6200 | 6400 | 6500 |
| Voltage code                      |           | 54            | 56   | 58   | 60   | 62   | 64   | 65   |
| $T_j, ^\circ C$                   |           | – 60 – 125    |      |      |      |      |      |      |

## MAXIMUM ALLOWABLE RATINGS

| Symbols and parameters |  | Units             | Values                                       | Test conditions   |   |
|------------------------|--|-------------------|--|---|---|
| <b>ON-STATE</b>        |  |                   |  |   |   |
| $I_{TAV}$              | Mean on-state current  | A                 | 1600   | $T_c = 85^\circ C$ , Double side cooled<br>180° half-sine wave; 50 Hz                   |   |
| $I_{TRMS}$             | RMS on-state current   | A                 | 2512   | $T_c = 85^\circ C$ , Double side cooled<br>180° half-sine wave; 50 Hz                   |   |
| $I_{TSM}$              | Surge on-state current   | kA                | 40.0<br>46.0                                 | $T_j = T_{jmax}$<br>$T_j = 25^\circ C$  | 180° half-sine wave; 50 Hz<br>( $t_p = 10$ ms); single pulse;<br>$V_D = V_R = 0$ V;<br>Gate pulse: $I_G = 2$ A;<br>$t_{GP} = 50 \mu s$ ; $di_G/dt \geq 1$ A/ $\mu s$  |
|                        |  |                   | 42.0<br>48.0                                 |   | 180° half-sine wave; 60 Hz<br>( $t_p = 8.3$ ms); single pulse;<br>$V_D = V_R = 0$ V;<br>Gate pulse: $I_G = 2$ A;<br>$t_{GP} = 50 \mu s$ ; $di_G/dt \geq 1$ A/ $\mu s$ |
| $I^2t$                 | Safety factor  | $A^2s \cdot 10^3$ | 8000<br>10580                                | $T_j = T_{jmax}$<br>$T_j = 25^\circ C$  | 180° half-sine wave; 50 Hz<br>( $t_p = 10$ ms); single pulse;<br>$V_D = V_R = 0$ V;<br>Gate pulse: $I_G = 2$ A;<br>$t_{GP} = 50 \mu s$ ; $di_G/dt \geq 1$ A/ $\mu s$  |
|                        |  |                   | 7320<br>9560                                 |   | 180° half-sine wave; 60 Hz<br>( $t_p = 8.3$ ms); single pulse;<br>$V_D = V_R = 0$ V;<br>Gate pulse: $I_G = 2$ A;<br>$t_{GP} = 50 \mu s$ ; $di_G/dt \geq 1$ A/ $\mu s$ |
| <b>BLOCKING</b>        |  |                   |  |   |   |
| $V_{DRM}, V_{RRM}$     | Repetitive peak off-state and Repetitive peak reverse voltages         | V                 | 5400–6500                                    | $T_{jmin} < T_j < T_{jmax}$ ;<br>180° half-sine wave; 50 Hz;<br>Gate open               |   |
| $V_{DSM}, V_{RSM}$     | Non-repetitive peak off-state and Non-repetitive peak reverse voltages | V                 | 5500–6600                                    | $T_{jmin} < T_j < T_{jmax}$ ;<br>180° half-sine wave; 50 Hz; single pulse;<br>Gate open |   |
| $V_D, V_R$             | Direct off-state and Direct reverse voltages                           | V                 | $0.75 \cdot V_{DRM}$<br>$0.75 \cdot V_{RRM}$ | $T_j = T_{jmax}$ ;<br>Gate open   |   |

| <b>TRIGGERING</b>  |   |                  |             |  |
|--------------------|---|------------------|-------------|--|
| $I_{FGM}$          | Peak forward gate current   | A                | 10          | $T_j = T_{j\max}$  |
| $V_{RGM}$          | Peak reverse gate voltage   | V                | 5           |  |
| $P_G$              | Gate power dissipation  | W                | 5           | $T_j = T_{j\max}$ for DC gate current  |
| <b>SWITCHING</b>   |   |                  |             |  |
| $(di_T/dt)_{crit}$ | Critical rate of rise of on-state current non-repetitive (f=1 Hz) | A/ $\mu$ s       | 630         | $T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ;<br>$I_{TM} = 2 I_{TAV}$ ;<br>Gate pulse: $I_G = 2$ A;<br>$t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s |
| <b>THERMAL</b>     |   |                  |             |  |
| $T_{stg}$          | Storage temperature   | $^{\circ}$ C     | -60 - 125   |  |
| $T_j$              | Operating junction temperature                                    | $^{\circ}$ C     | -60 - 125   |  |
| <b>MECHANICAL</b>  |   |                  |             |  |
| F                  | Mounting force  | kN               | 60.0 - 70.0 |  |
| a                  | Acceleration  | m/s <sup>2</sup> | 50<br>100   | Device unclamped<br>Device clamped   |

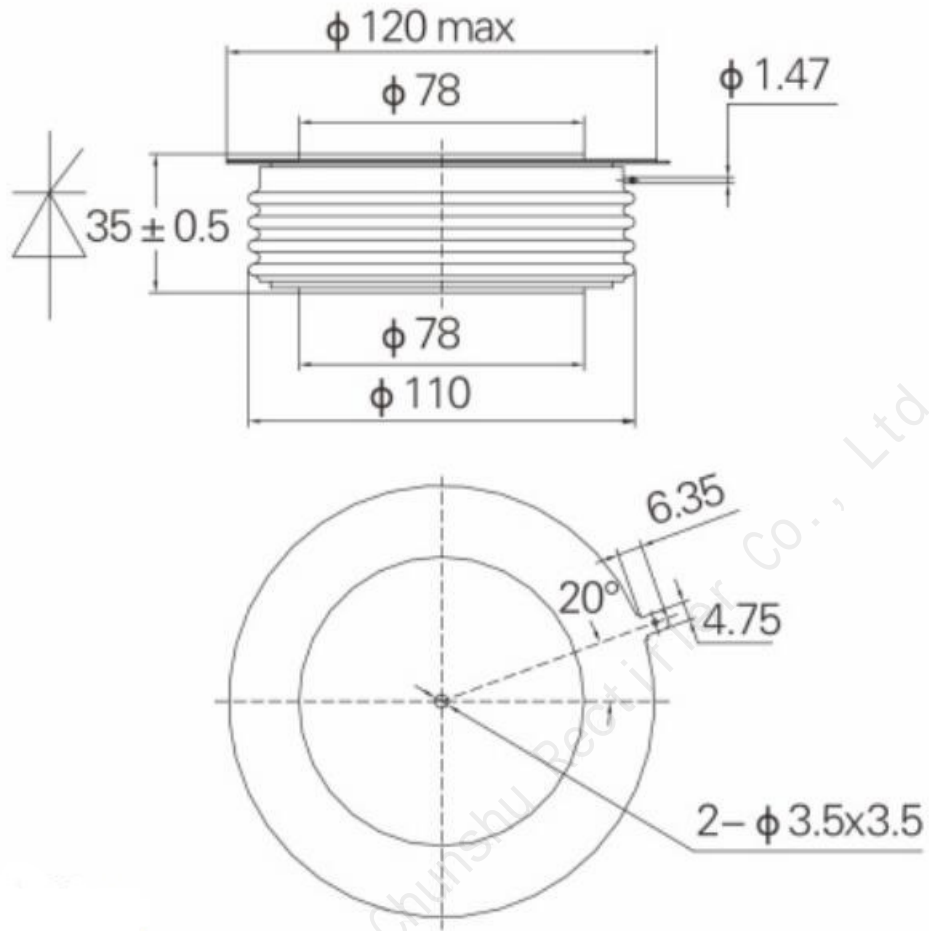
## CHARACTERISTICS

| Symbols and parameters |   | Units      | Values       | Conditions   |   |
|------------------------|---|------------|--------------|--|---|
| <b>ON-STATE</b>        |   |            |              |  |   |
| $V_{TM}$               | Peak on-state voltage, max  | V          | 2.80         | $T_j = 25 \text{ }^{\circ}\text{C}$ ; $I_{TM} = 6300$ A  |   |
| $V_{T(TO)}$            | On-state threshold voltage, max                                     | V          | 1.10         | $T_j = T_{j\max}$  |   |
| $r_T$                  | On-state slope resistance, max                                      | m $\Omega$ | 0.350        | $0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$  |   |
| $I_L$                  | Latching current, max   | mA         | 1500         | $T_j = 25 \text{ }^{\circ}\text{C}$ ; $V_D = 12$ V;<br>Gate pulse: $I_G = 2$ A;<br>$t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s                                    |   |
| $I_H$                  | Holding current, max  | mA         | 300          | $T_j = 25 \text{ }^{\circ}\text{C}$ ;<br>$V_D = 12$ V; Gate open   |   |
| <b>BLOCKING</b>        |   |            |              |  |   |
| $I_{DRM}$ , $I_{RRM}$  | Repetitive peak off-state and Repetitive peak reverse currents, max | mA         | 200          | $T_j = T_{j\max}$ ;<br>$V_D = V_{DRM}$ ; $V_R = V_{RRM}$   |   |
| $(dv_D/dt)_{crit}$     | Critical rate of rise of off-state voltage <sup>1)</sup> , min      | V/ $\mu$ s | 1000         | $T_j = T_{j\max}$ ;<br>$V_D = 0.67 \cdot V_{DRM}$ ; Gate open  |   |
| <b>TRIGGERING</b>      |   |            |              |  |   |
| $V_{GT}$               | Gate trigger direct voltage, max                                    | V          | 3.00<br>2.00 | $T_j = 25 \text{ }^{\circ}\text{C}$<br>$T_j = T_{j\max}$   | $V_D = 12$ V; $I_D = 3$ A;<br>Direct gate current |
| $I_{GT}$               | Gate trigger direct current, max                                    | mA         | 300<br>200   | $T_j = 25 \text{ }^{\circ}\text{C}$<br>$T_j = T_{j\max}$   |   |
| $V_{GD}$               | Gate non-trigger direct voltage, min                                | V          | 0.35         | $T_j = T_{j\max}$ ;<br>$V_D = 0.67 \cdot V_{DRM}$ ;  |   |
| $I_{GD}$               | Gate non-trigger direct current, min                                | mA         | 15.00        | Direct gate current  |   |
| <b>SWITCHING</b>       |   |            |              |  |   |
| $t_{gd}$               | Delay time  | $\mu$ s    | 4.00         | $T_j = 25 \text{ }^{\circ}\text{C}$ ; $V_D = 0.4 \cdot V_{DRM}$ ; $I_{TM} = I_{TAV}$ ;<br>Gate pulse: $I_G = 2$ A;<br>$t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s |   |
| $t_q$                  | Turn-off time <sup>2)</sup> , max                                   | $\mu$ s    | 800          | $dv_D/dt = 50$ V/ $\mu$ s; $T_j = T_{j\max}$ ; $I_{TM} = 2000$ A;<br>$di_R/dt = -10$ A/ $\mu$ s; $V_R = 100$ V;<br>$V_D = 0.67 V_{DRM}$                                |   |
| $Q_{rr}$               | Total recovered charge, max   | $\mu$ C    | 7600         | $T_j = T_{j\max}$ ; $I_{TM} = 2000$ A;   |   |
| $t_{rr}$               | Reverse recovery time, typ  | $\mu$ s    | 80           | $di_R/dt = -5$ A/ $\mu$ s;   |   |
| $I_{rrM}$              | Peak reverse recovery current, max                                  | A          | 190          | $V_R = 100$ V  |   |

| <b>THERMAL</b>    |   |              |                  |                |                     |
|-------------------|---|--------------|------------------|----------------|---------------------|
| $R_{thjc}$        | Thermal resistance, junction to case, max | °C/W         | 0.0075           | Direct current | Double side cooled  |
| $R_{thjc-A}$      |   |              | 0.0165           |                | Anode side cooled   |
| $R_{thjc-K}$      |   |              | 0.0135           |                | Cathode side cooled |
| $R_{thck}$        | Thermal resistance, case to heatsink, max | °C/W         | 0.0015           | Direct current |                     |
| <b>MECHANICAL</b> |   |              |                  |                |                     |
| w                 | Weight, typ                               | g            | 2200             |                |                     |
| $D_s$             | Surface creepage distance                 | mm<br>(inch) | 45.40<br>(1.787) |                |                     |
| $D_a$             | Air strike distance                       | mm<br>(inch) | 25.50<br>(1.004) |                |                     |

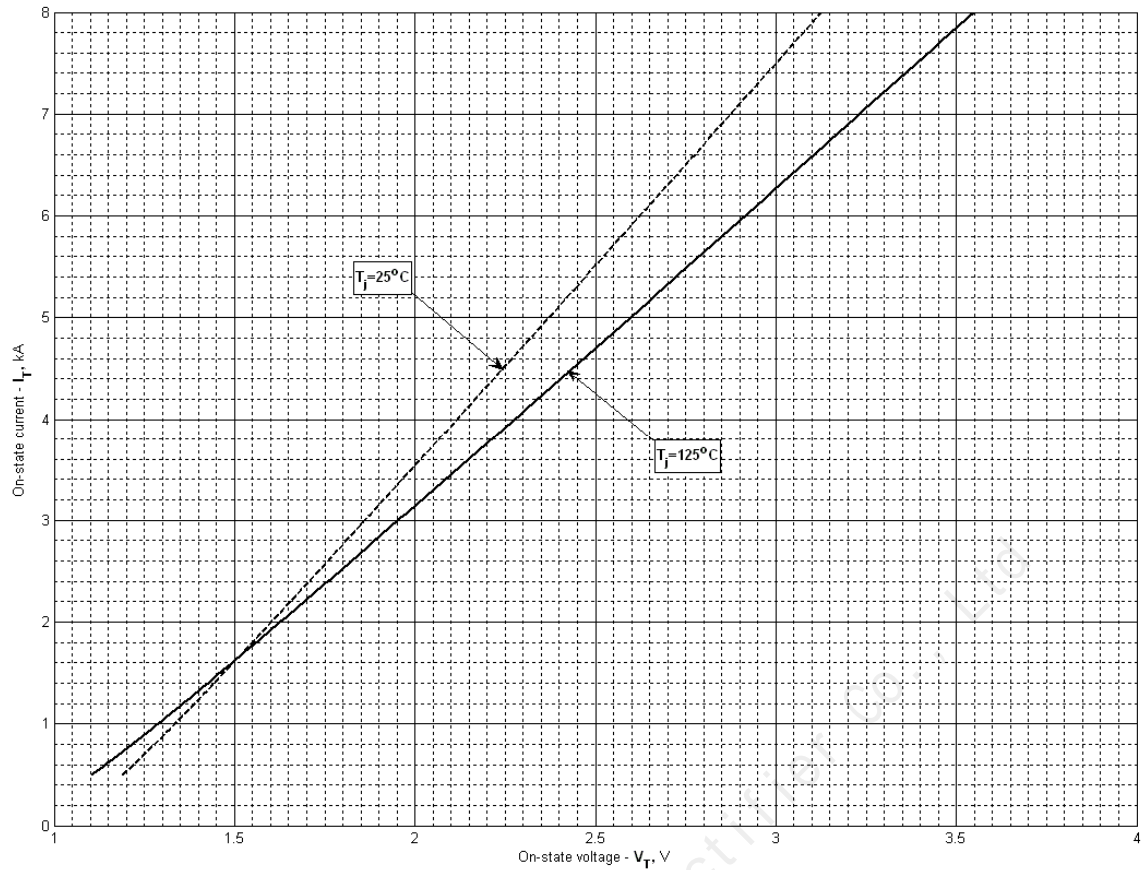
Beijing Xinchuang Chunshu Rectifier Co., Ltd

OVERALL DIMENSIONS



KT85DT

All dimensions in millimeters



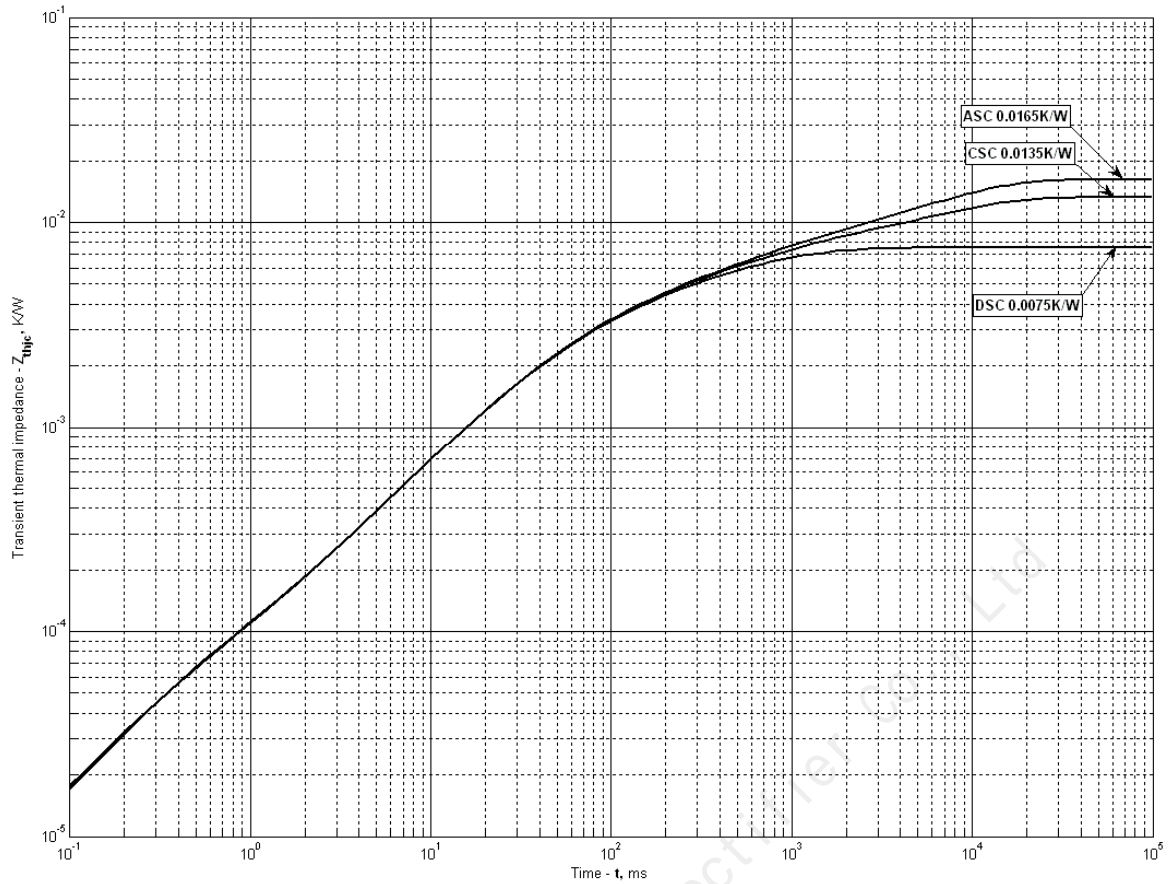
**Fig 1 – On-state characteristics of Limit device**

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

|          | Coefficients for max curves |                   |
|----------|-----------------------------|-------------------|
|          | $T_j = 25^\circ\text{C}$    | $T_j = T_{j,max}$ |
| <b>A</b> | 0.913434                    | 0.744654          |
| <b>B</b> | 0.208728                    | 0.259885          |
| <b>C</b> | -0.253813                   | -0.338985         |
| <b>D</b> | 0.388412                    | 0.518752          |

**On-state characteristic model (see Fig. 1)**



**Fig 2 – Transient thermal impedance**

Analytical function for Transient thermal impedance junction to case  $Z_{thjc}$  for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left( 1 - e^{-\frac{t}{\tau_i}} \right)$$

Where  $i = 1$  to  $n$ ,  $n$  is the number of terms in the series.

$t$  = Duration of heating pulse in seconds.

$Z_{thjc}$  = Thermal resistance at time  $t$ .

$R_i$  = Amplitude of  $p_{th}$  term.

$\tau_i$  = Time constant of  $r_{th}$  term.

DC Double side cooled

| $i$           | 1        | 2        | 3        | 4         | 5          | 6          |
|---------------|----------|----------|----------|-----------|------------|------------|
| $R_i$ K/W     | 0.002867 | 0.002105 | 0.002075 | 0.0004109 | 1.711e-005 | 2.554e-005 |
| $\tau_{ij}$ s | 0.7465   | 0.05807  | 0.2131   | 0.0169    | 0.0008236  | 0.0002536  |

DC Cathode side cooled

| $i$           | 1        | 2        | 3        | 4        | 5         | 6          |
|---------------|----------|----------|----------|----------|-----------|------------|
| $R_i$ K/W     | 0.005752 | 0.002964 | 0.001955 | 0.002111 | 0.0004223 | 4.033e-005 |
| $\tau_{ij}$ s | 7.357    | 0.7795   | 0.2131   | 0.05907  | 0.01687   | 0.0003644  |

DC Anode side cooled

| $i$           | 1        | 2        | 3        | 4        | 5         | 6          |
|---------------|----------|----------|----------|----------|-----------|------------|
| $R_i$ K/W     | 0.008691 | 0.003005 | 0.001922 | 0.002105 | 0.0004208 | 4.031e-005 |
| $\tau_{ij}$ s | 7.360    | 0.8002   | 0.2128   | 0.05911  | 0.01686   | 0.0003642  |

**Transient thermal impedance junction to case  $Z_{thjc}$  model (see Fig. 2)**

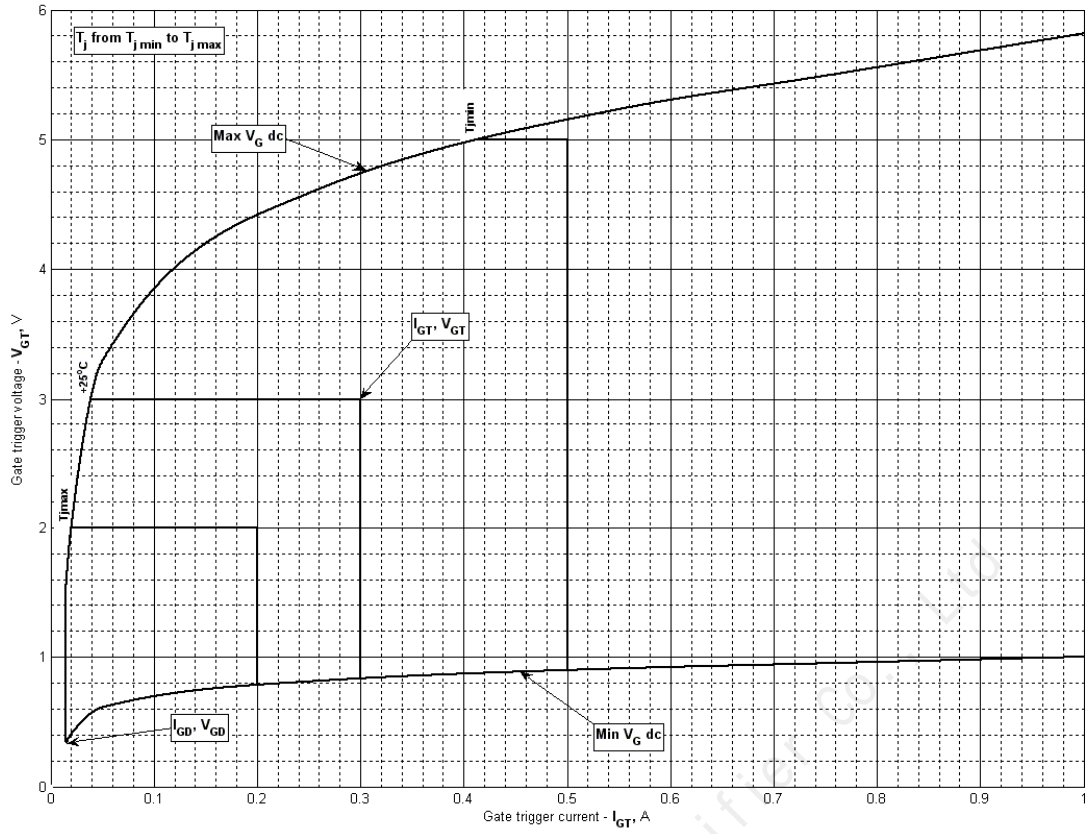


Fig 3 – Gate characteristics – Trigger limits

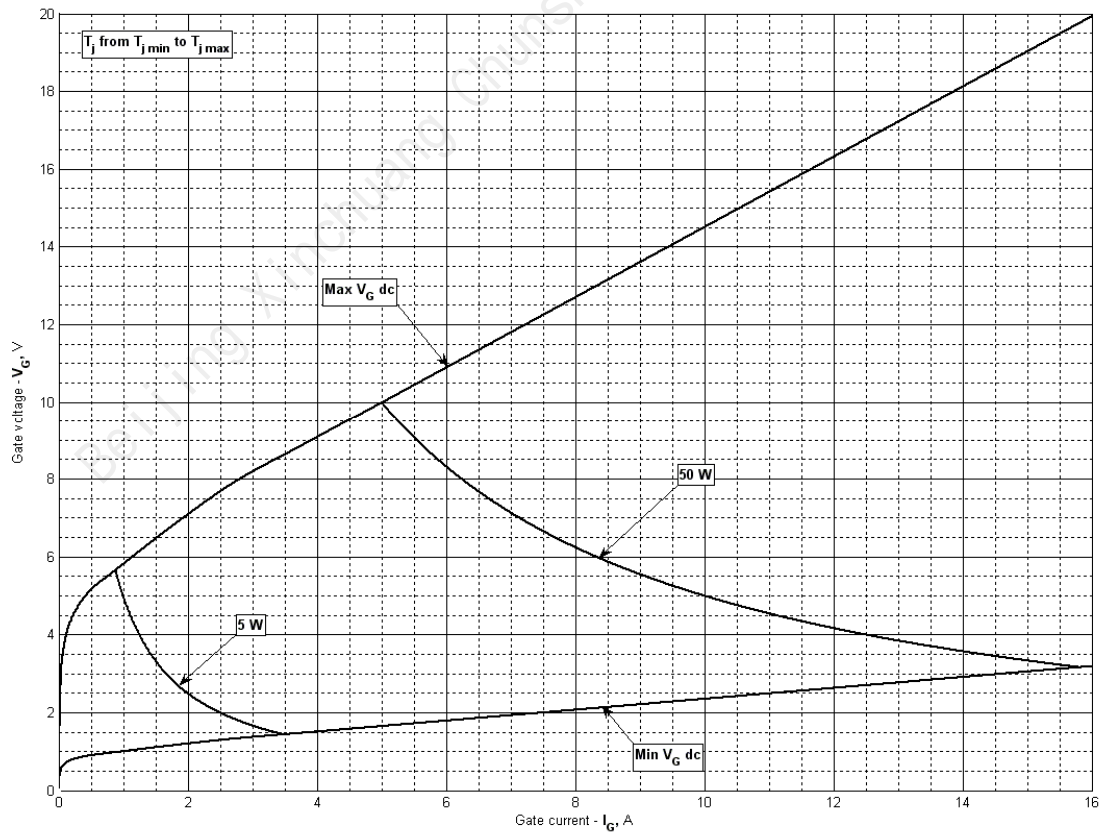
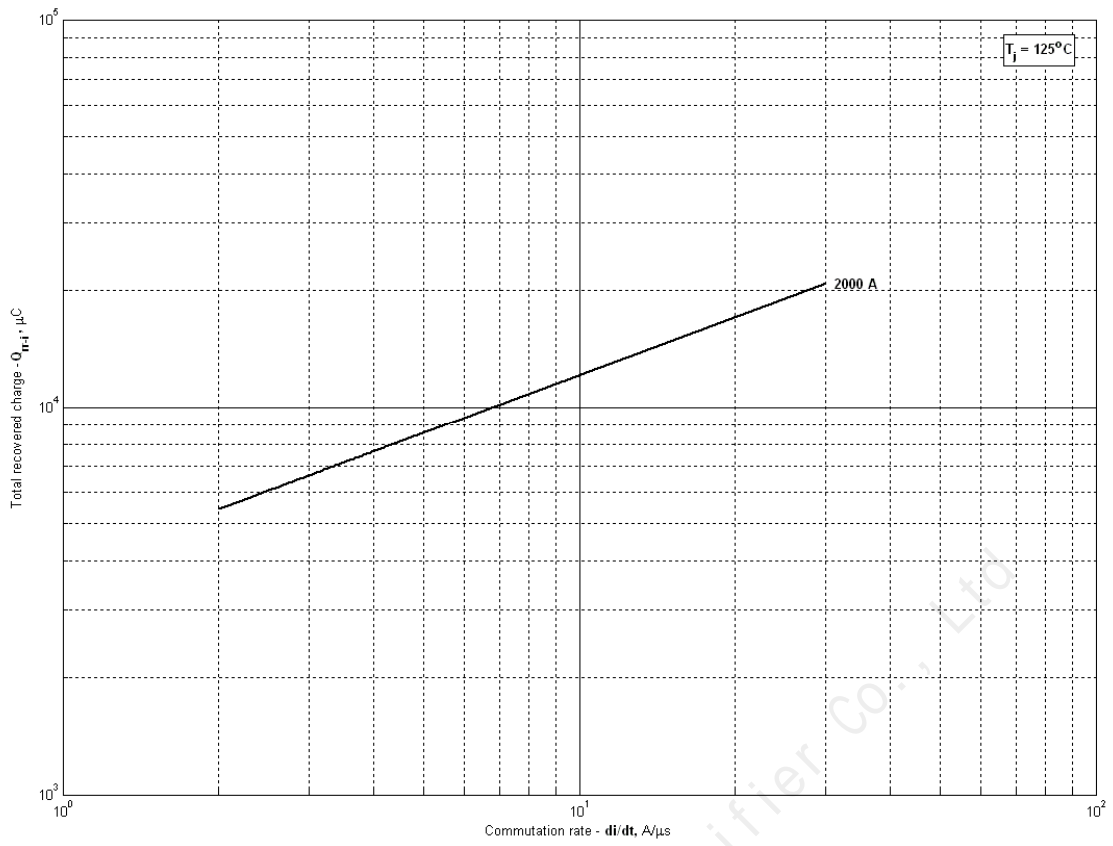


Fig 4 - Gate characteristics –Power curves

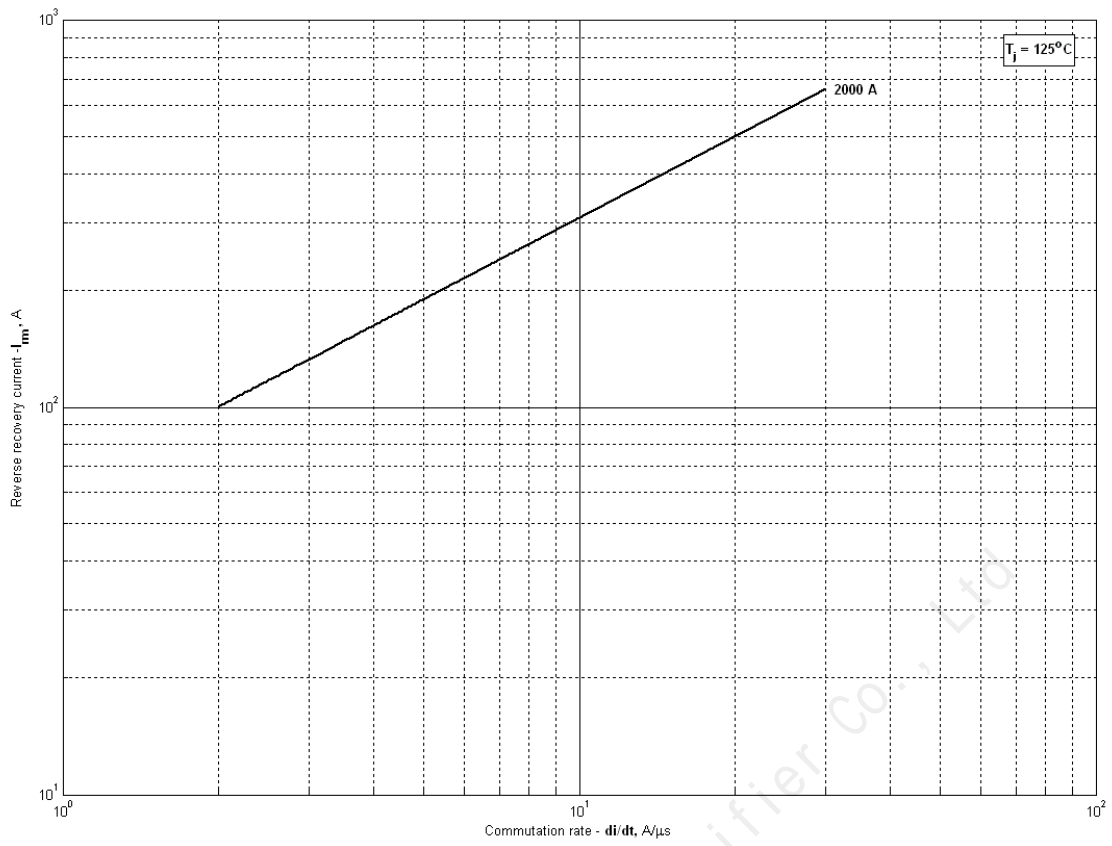


**Fig 5 – Total recovered charge,  $Q_{rr-i}$  (integral)**

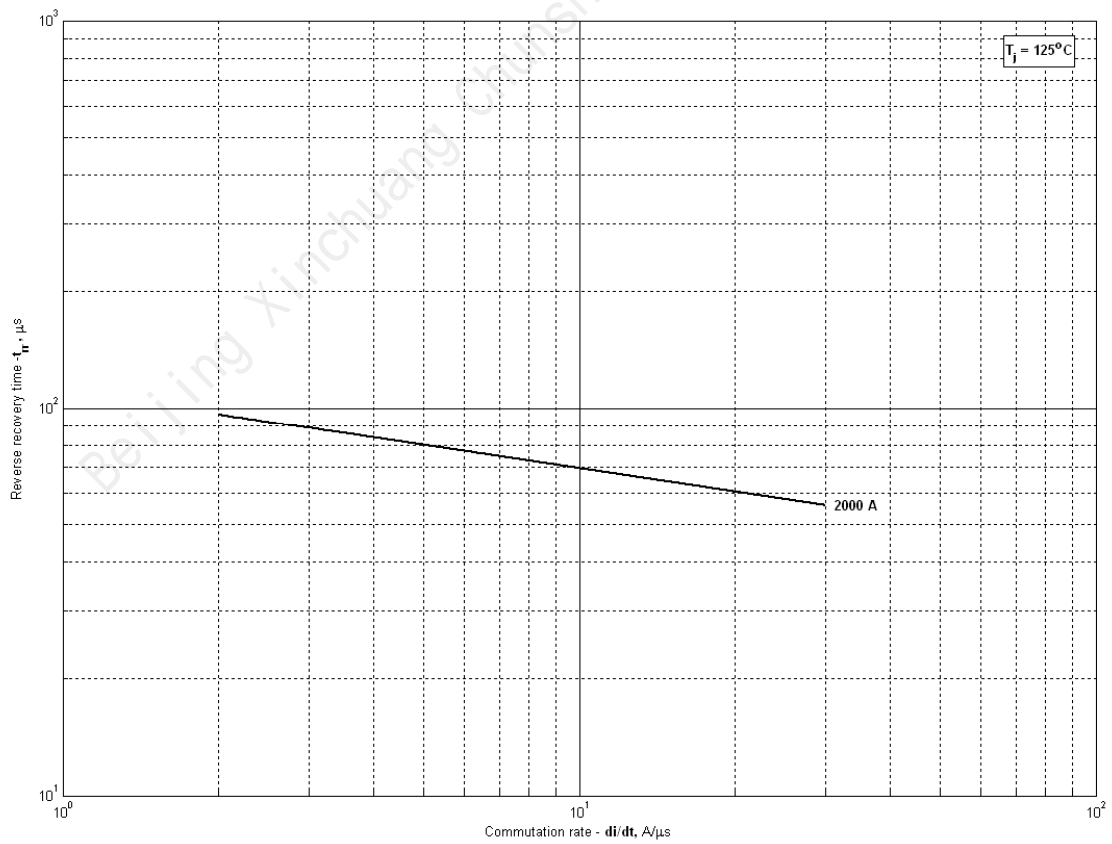


**Fig 6 - Recovered charge,  $Q_{rr}$  (linear)**

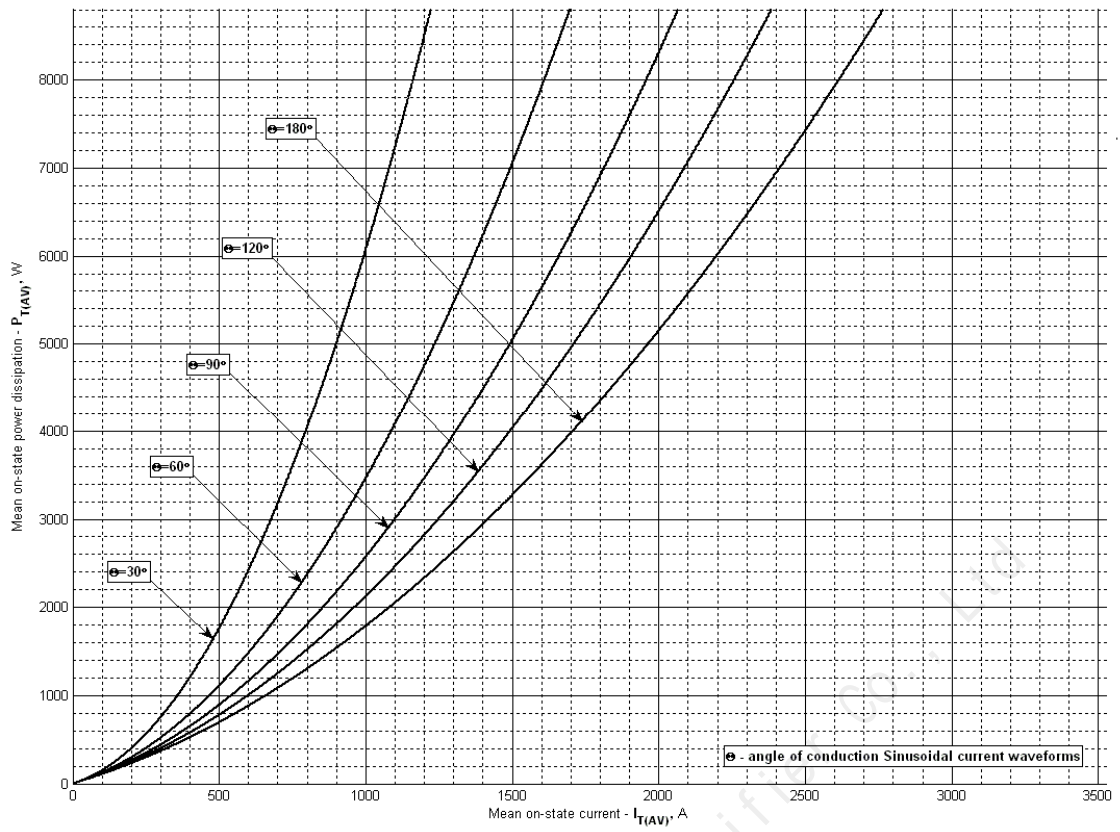




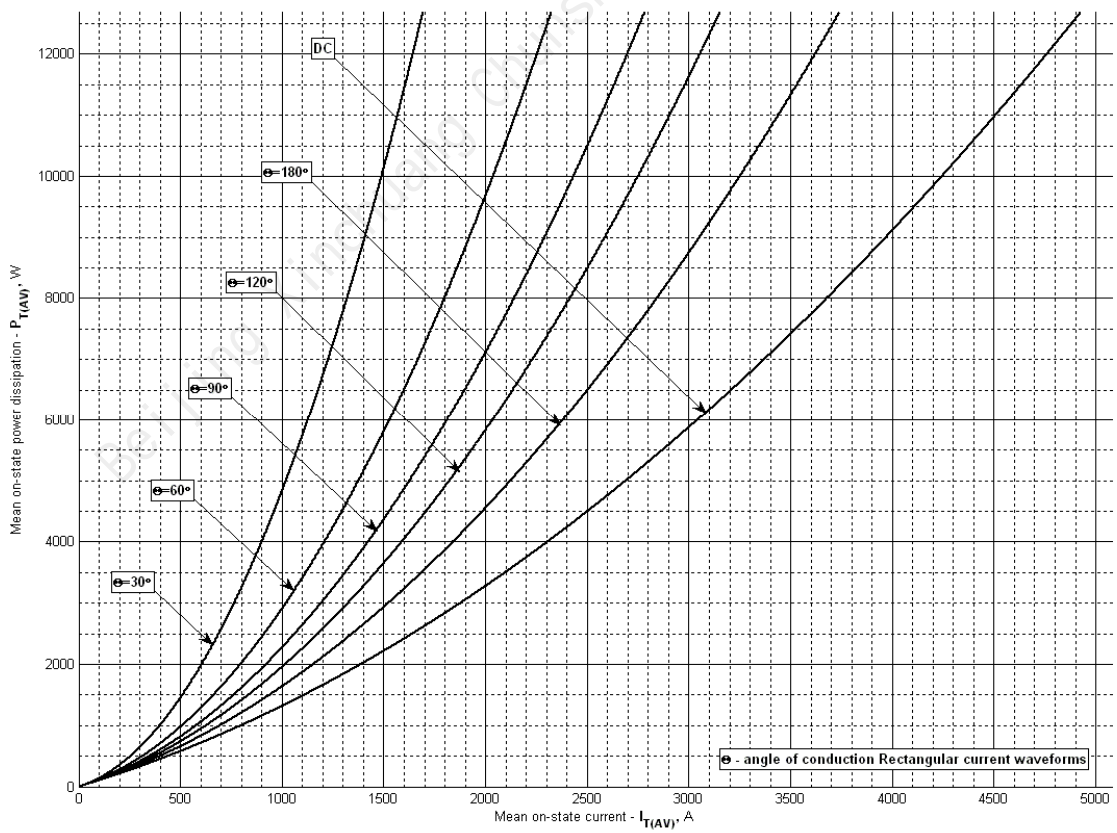
**Fig 7 – Peak reverse recovery current,  $I_{rm}$**



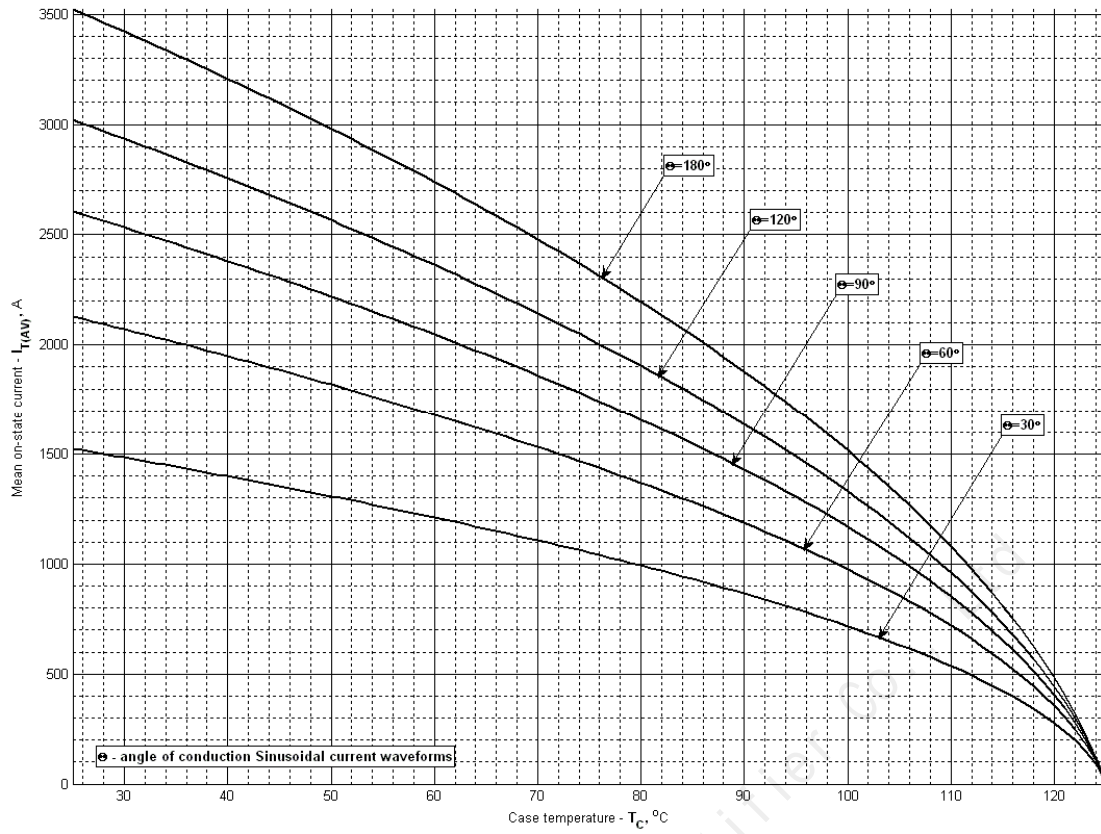
**Fig 8 – Maximum recovery time,  $t_{rr}$  (linear)**



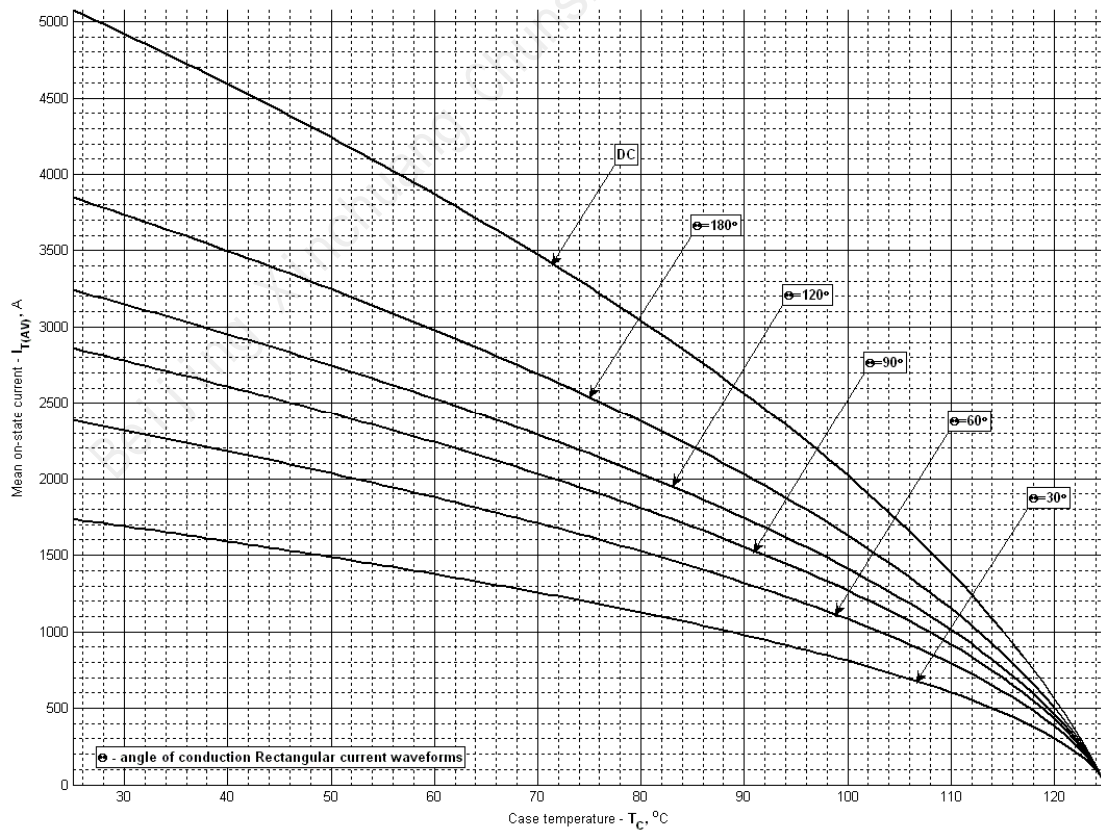
**Fig 9 – On-state power loss (sinusoidal current waveforms)**



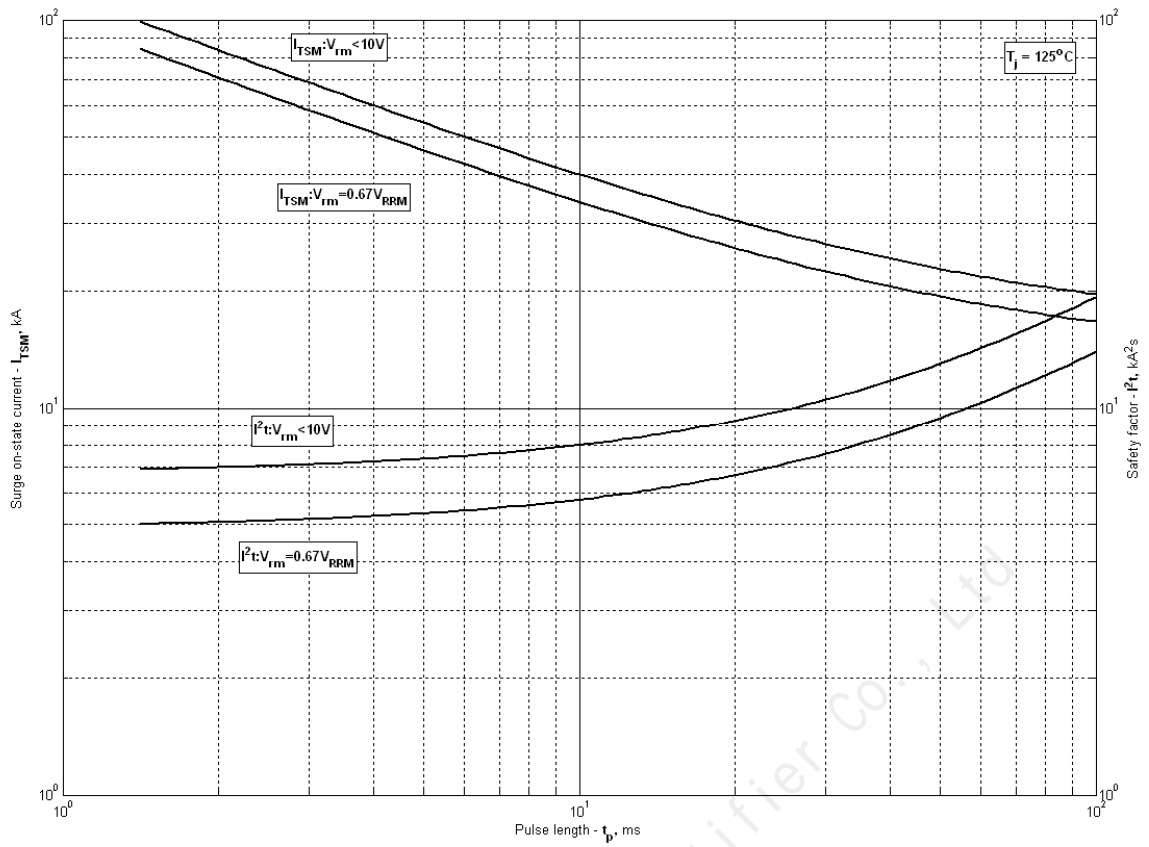
**Fig 10 – On-state power loss (rectangular current waveforms)**



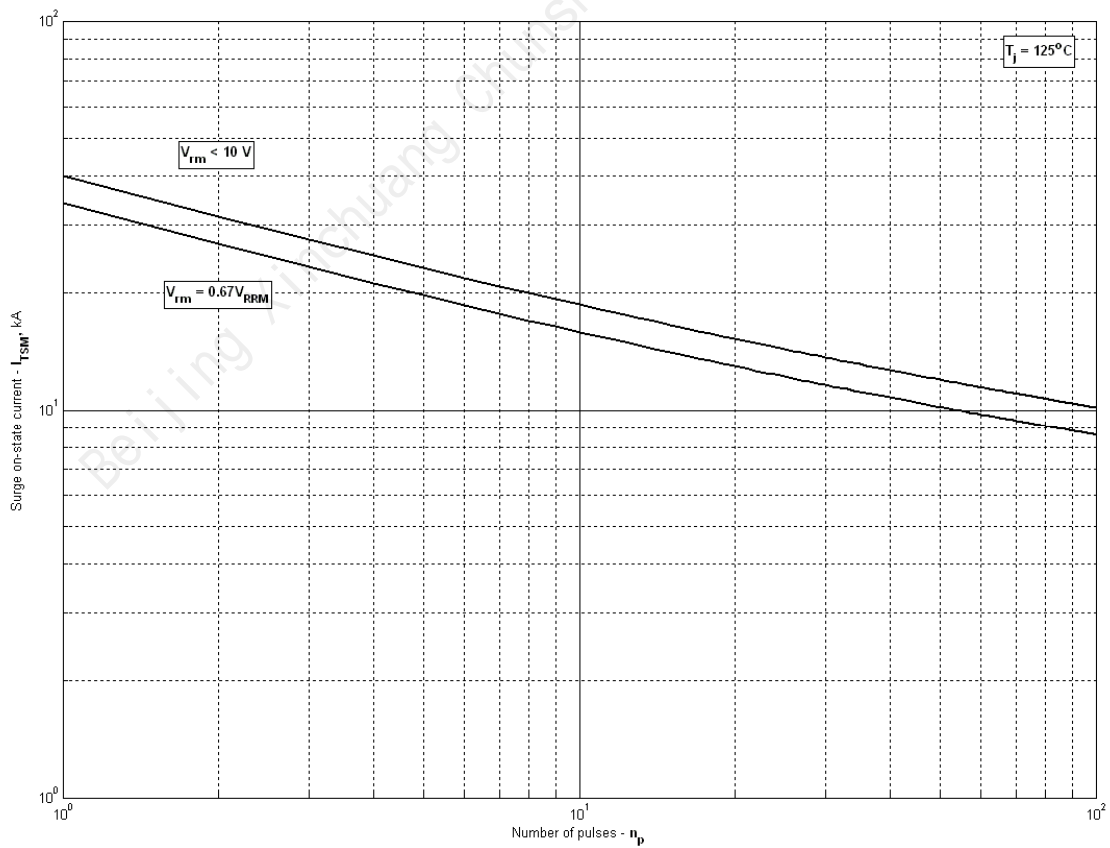
**Fig 11 – Maximum case temperature DSC (sinusoidal current waveforms)**



**Fig 12 – Maximum case temperature DSC (rectangular current waveforms)**



**Fig 13 – Maximum surge and  $I^2t$  ratings**



**Fig 14 – Maximum surge ratings**